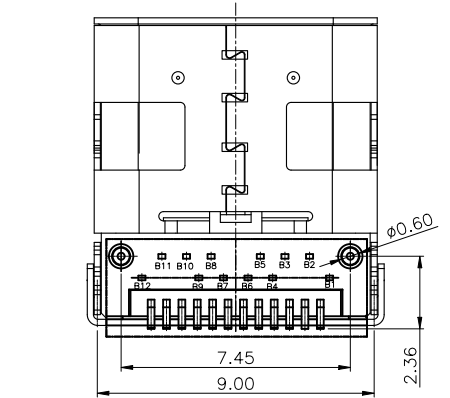
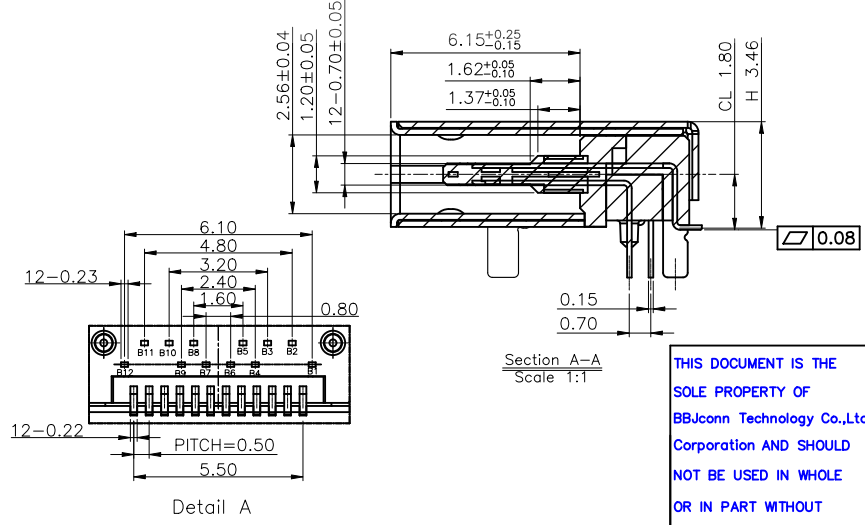
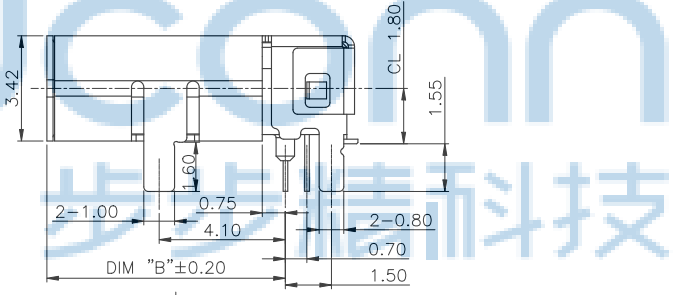
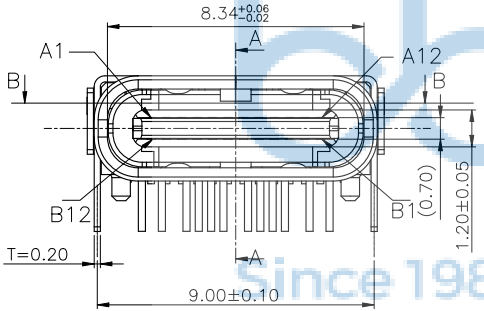
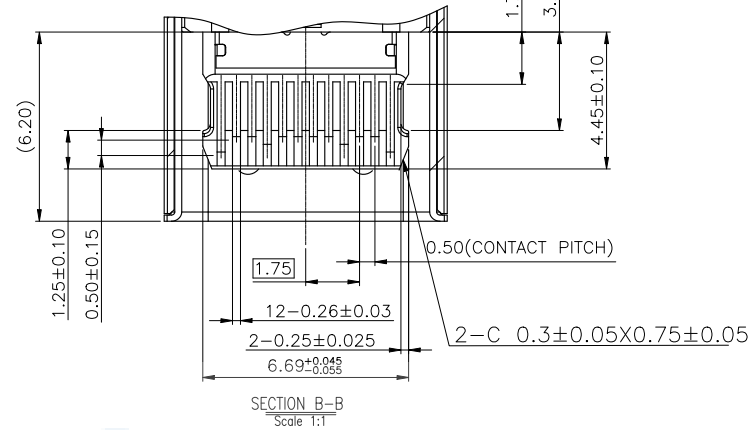
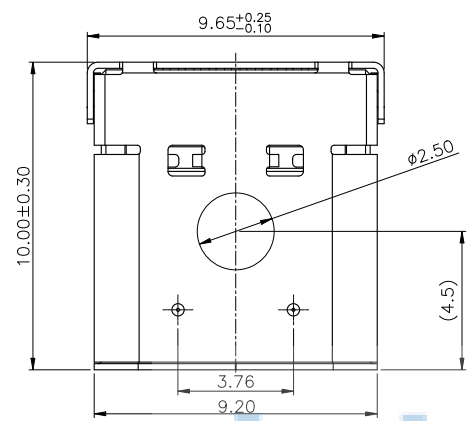


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	GZY

- MATERIAL:**
MOLDING: LCP UL94 V-0
CONTACT: COPPER ALLOY.
PLATED GOLD ON CONTACT AREA,
G/F GOLD ON SOLDER AREA,
50u" NICKEL PLATING OVER ALL.

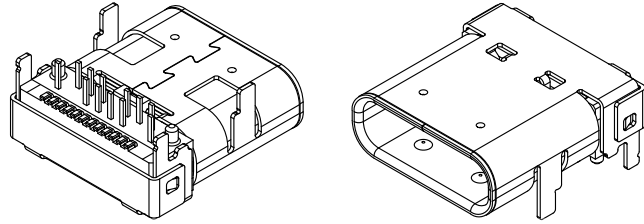
SHELL: SUS304-H,T=0.20±0.03mm
50u" NICKEL PLATING OVER ALL.
EMI SHILD: SUS304-H,T=0.12±0.03mm
LATCH: SUS301-H,T=0.15±0.03mm
- MECHANICAL:**
INSERTION: 5~20N.
EXTRACTION: 8~20N.
DURABILITY: 10000 CYCLES
- ELECTRICAL:**
CURRENT: 5A MAX FOR VBUS;
1.25A FOR GND, 0.25A FOR OTHER OTHER.
VOLTAGE: 20VDC MAX
WITHSTANDING VOLTAGE: 100V AC.
CONTACT RESISTANCE: 40mΩ MAX.
INSULATION RESISTANCE: 100MΩ MIN.
- ENVIRONMENTAL**
TEMPERATURE RANGE: -30°C TO +80°C



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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	.X': ±3' .X'': ±2' .X'X': ±1'	NAME: TYPE-C 母座 24P 板上型 双壳 四脚DIP 端子DIP+SMT L=10.00 CH=1.80 外壳脚长1.60 带柱 编带	PJ. NO.: 126-223-240020-T7G SIZE: A4 DRW NO.: FINISH: SEE NOTES MAT'L.: SEE NOTES SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/4
APPD. JM_Zheng	CHKD. LYX	DR. GZY	

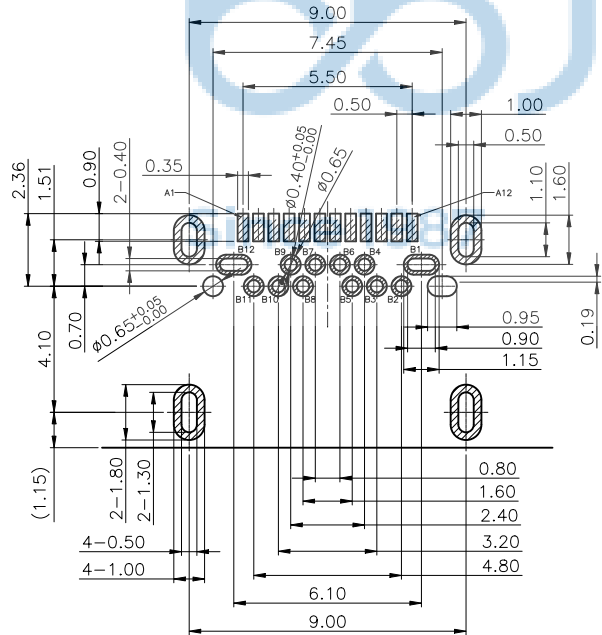


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	GZY



USB TYPE-C FULL-FEATURED RECEPTACLE INTERFACE PIN ASSIGNMENTS

PIN	Signal Name	Description	PIN	Signal Name	Description
A1	GND	Ground return	B12	GND	Ground return
A2	SSTXp1	Positive half of first SuperSpeed TX differential pair	B11	SSRXp1	Positive half of first SuperSpeed RX differential pair
A3	SSTXn1	Negative half of first SuperSpeed TX differential pair	B10	SSRXn1	Negative half of first SuperSpeed RX differential pair
A4	VBUS	Bus Power	B9	VBUS	Bus Power
A5	CC1	Configuration Channel	B8	SBU2	Sideband Use (SBU)
A6	Dp1	Positive half of the USB 2.0 differential pair-Position 1	B7	Dn2	Negative half of the USB 2.0 differential pair-Position 2
A7	Dn1	Negative half of the USB 2.0 differential pair-Position 1	B6	Dp2	Positive half of the USB 2.0 differential pair-Position 2
A8	SBU1	Sideband Use(SBU)	B5	CC2	Configuraation Channel
A9	VBUS	Bus Power	B4	VBUS	Bus Power
A10	SSRXn2	Negative half of second SuperSpeed RX differential pair	B3	SSTXn2	Negative half of second SuperSpeed TX differential pair
A11	SSRXp2	Positive half of second SuperSpeed RX differential pair	B2	SSTXp2	Positive half of second SuperSpeed TX differential pair
A12	GND	Ground return	B1	GND	Ground return



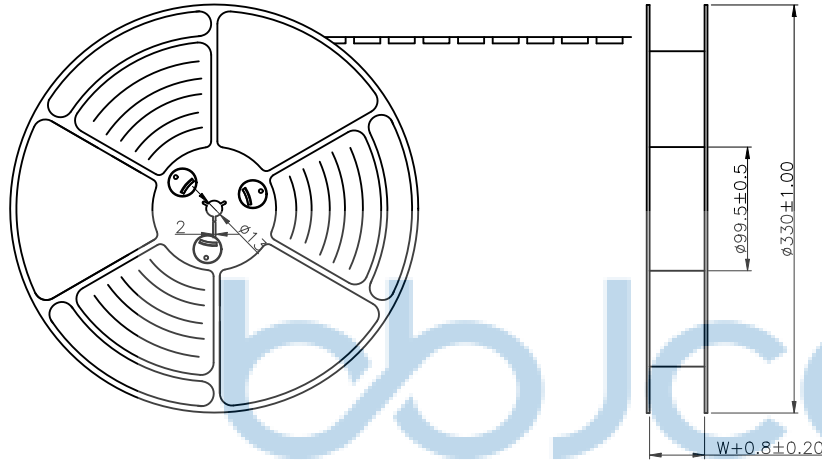
RECOMMEND P.C.B LAYOUT(COMPONENT SIDE)
TOLERANCE FOR PCB LAYOUT IS ± 0.05



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<p>PDWG.NO: 0228-1</p>		<p>NAME: TYPE-C 母座 24P 板上型 双壳 四脚DIP 端子DIP+SMT L=10.00 CH=1.80 外壳脚长1.60 带柱 编带</p>	
<p>APPD. JM_Zheng</p>		<p>PJ. NO.: 126-223-240020-T7G</p>	
<p>CHKD. LYX</p>		<p>SIZE: A4 DRW NO.:</p>	
<p>DR. GZY</p>		<p>FINISH: SEE NOTES MAT'L.: SEE NOTES</p>	
		<p>SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/4</p>	

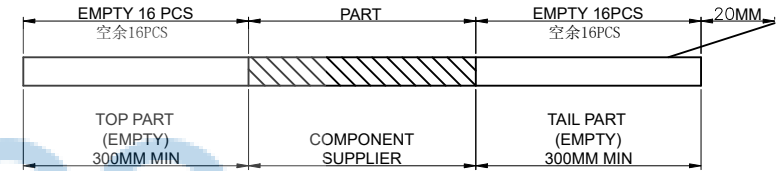
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	GZY

出料方向
PULL OUT DIRECTEON



NOTES

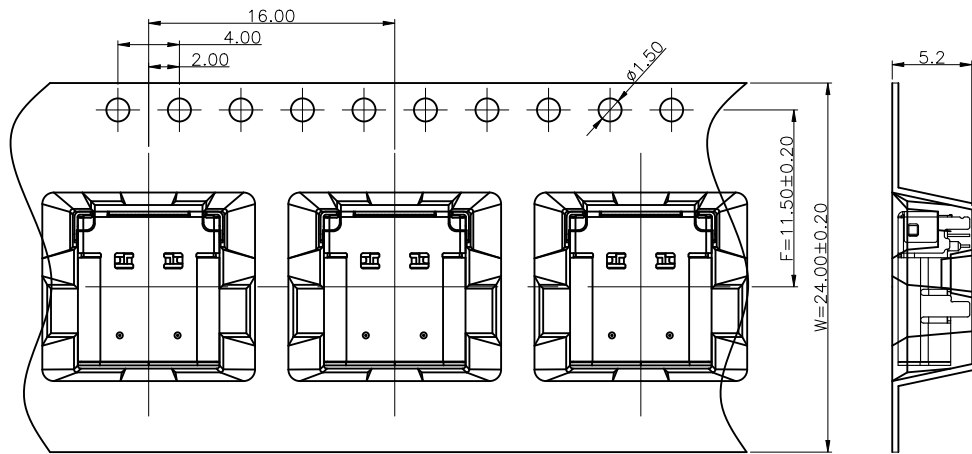
- 帶子引導長度
LEAD TAPE LENGTH
出料方向
PULL OUT DIRECTEON



- 出貨運輸過程中一定要注意：
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT：
卷帶在運輸過程中不能散開
PEELING OFF SHOULD NOT BE ALLOWED DURING TRANSPORTATION

Since 1987

步步精科技



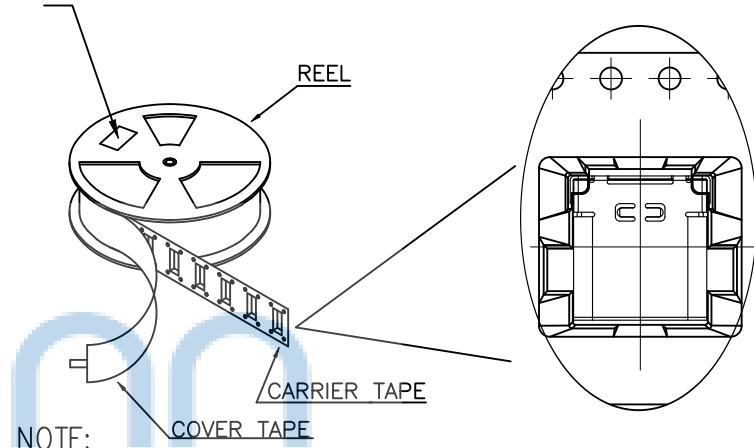
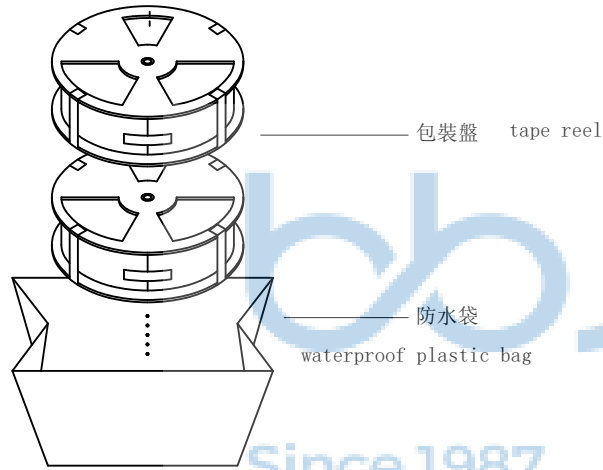
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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X': ±3" .X': ±2" .XX': ±1"	
APPD.	JM_Zheng	NAME: TYPE-C 母座 24P 板上型 双壳 四脚DIP 端子DIP+SMT L=10.00 CH=1.80 外壳脚长1.60 带柱 编带	
CHKD.	LYX	PJ. NO.: 126-223-240020-T7G SIZE: A4 DRW NO.:	
PDWG.NO:	0228-1	FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 3/4	

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	GZY



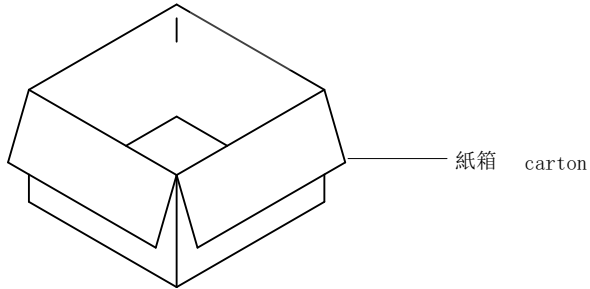
at small positioning hole of the carrier tape side).
標籤黏貼處 (朝捲裝包材的小定位孔一側)

Location of label sticking (label)



NOTE:

1. 每捲包裝數量及每箱裝箱數量如左下表格。
Packing q'ty of each reel & carton as below table shown.
2. 以上膠帶覆蓋下包裝帶經包裝機熱熔包裝
Use cover tape to cover and hot melt machine to seal up.
3. 將裝滿產品的卷盤放入紙箱并以膠帶封口
Put reels in the carton and use adhesive tape to seal up.



包裝容量 (PACKING CAPACITY)			重量 WEIGHT (Kg)		
PCS/REEL	REELS/CARTON	PCS/CARTON	N.W./PCS	N.W./BOX	G.W./BOX
700	10	7000	0.704		

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APPD.	JM_Zheng		PJ. NO.: 126-223-240020-T7G		
CHKD.	LYX		SIZE: A4 DRW NO.:		
PDWG.NO:	0228-1	DR.	GZY	FINISH: SEE NOTES	MAT'L.: SEE NOTES
				SCALE: N/A	REV.: A0
				UNIT: mm	PAGE: 4/4